

# Board Level Cooling – Surface Mount 5731



## BOARD LEVEL COOLING – Surface Mount 5731

Surface Mount 5731 is a series of surface mount board level heat sinks designed to cool Dual Flat No-Leads (DFN) packages, Quad Flat No-Leads (QFN) packages and D2 Pak (TO-263) devices. Surface Mount 5731 can cool either a single D2 Pak, larger QFNs or DFNs, or multiple QFNs or DFNs. The tin plated surface of Surface Mount 5731 enables direct soldering to Printed Circuit Boards (PCBs) for effective board cooling.

573100D00000G is the bulk packaging option of Surface Mount 5731 and 573100D00010G is the tape and reel offering for high volume manufacturing. Representative image only.



## ORDERING INFORMATION

Part Number	Device Type
573100D00000G	D-Pak, TO-252
573100D00010G	D-Pak, TO-252

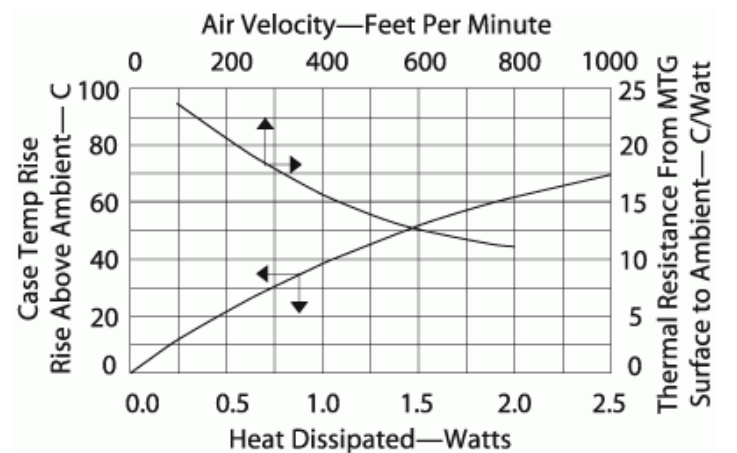
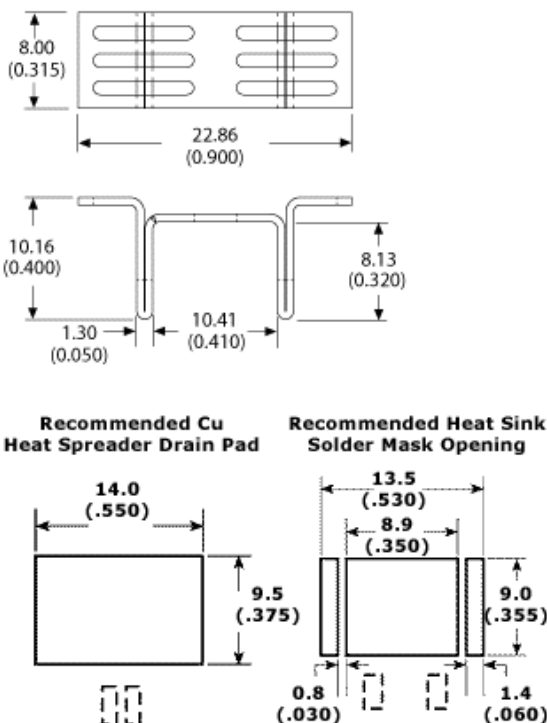
## HEAT SINK DETAILS

Property	Details
Material	Copper
Finish	Tin Plated
Device Attachment Options	-
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	8
Heat Sink Length (mm)	10.16
Heat Sink Height (mm)	22.86
Heat Sink Mounting Direction	Horizontal

## MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)



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